

# FQB13N50C / FQI13N50C N-Channel QFET MOSFET 500 V, 13 A, 480 mΩ

## Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

### **Features**

- + 13 A, 500 V,  ${\rm R}_{\rm DS(on)}$  = 480 m $\Omega$  (Max) @V\_{\rm GS} = 10 V,  ${\rm I}_{\rm D}$  = 6.5 A
- Low Gate Charge (Typ. 43 nC)
- Low Crss (Typ. 20 pF)
- 100% Avalanche Tested
- · RoHS compliant



### Absolute Maximum Ratings T<sub>c</sub> = 25°C unless otherwise noted

Symbol	Parameter		FQB13N50C / FQI13N50C	Units
V <sub>DSS</sub>	Drain-Source Voltage		500	V
I <sub>D</sub>	Drain Current - Continuous ( $T_C = 25^{\circ}C$ )		13	А
	- Continuous (T <sub>C</sub> = 100°C	)	8	А
I <sub>DM</sub>	Drain Current - Pulsed	(Note 1)	52	Α
V <sub>GSS</sub>	Gate-Source Voltage		± 30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy	(Note 2)	860	mJ
I <sub>AR</sub>	Avalanche Current	(Note 1)	13	А
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	19.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
PD	Power Dissipation ( $T_C = 25^{\circ}C$ )		195	W
	- Derate above 25°C		1.56	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

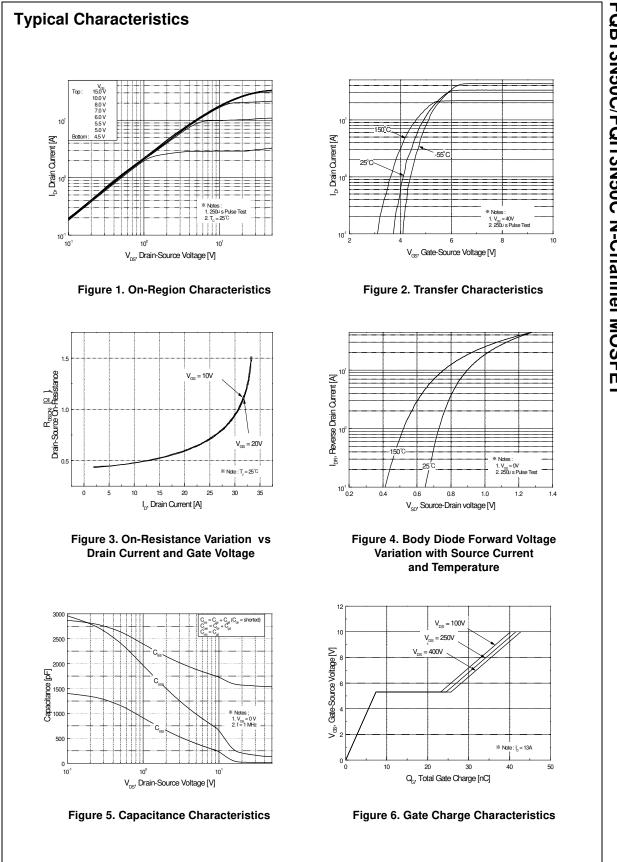
### **Thermal Characteristics**

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		0.64	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

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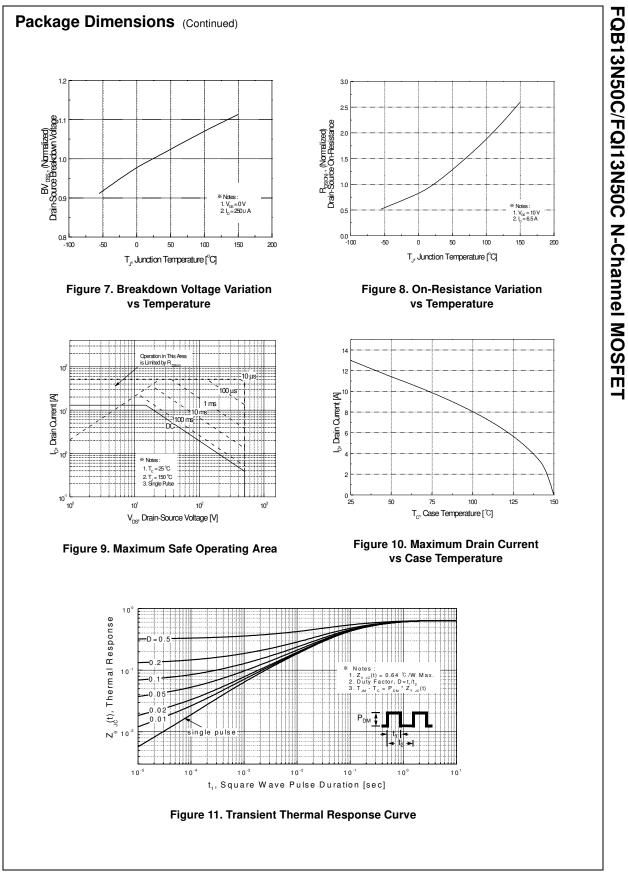
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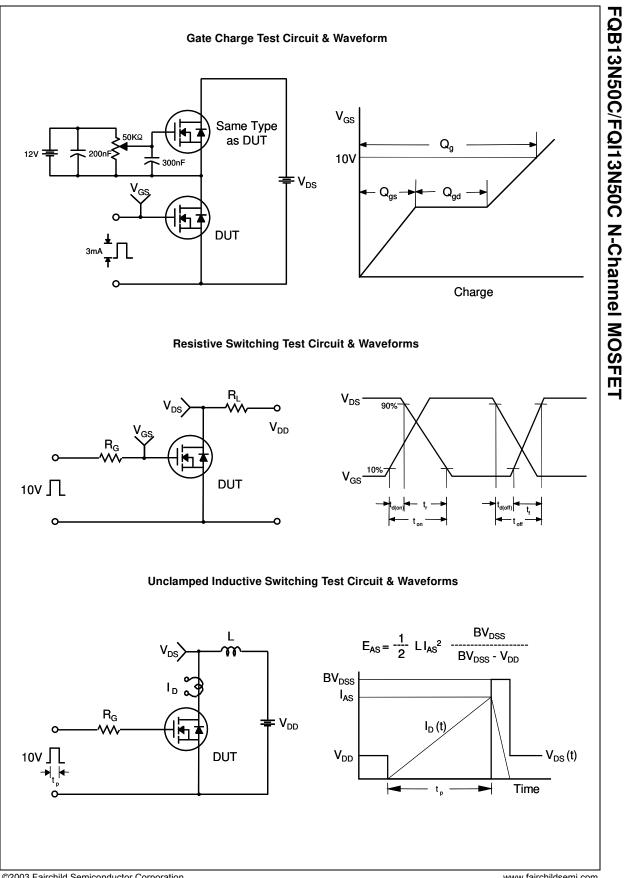
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Cha	iracteristics					
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA				V
ΔBV <sub>DSS</sub> ΔΤJ	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		0.5		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$V_{DS} = 400 \text{ V}, \text{ T}_{C} = 125^{\circ}\text{C}$			10	μA
GSSF	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
GSSR	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$			-100	nA
)n Cha	racteristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0		4.0	V
R <sub>DS(on)</sub>	Static Drain-Source					
DO(011)	On-Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 6.5 A		0.39	0.48	Ω
9FS	Forward Transconductance	$V_{DS} = 40 \text{ V}, \text{ I}_{D} = 6.5 \text{ A}$ (Note 4)		15		S
<b>.</b>						
	ic Characteristics		1	1500	0055	
C <sub>iss</sub>	Input Capacitance Output Capacitance	$V_{DS} = 25 V, V_{GS} = 0 V,$		1580	2055	pF
C <sub>oss</sub> C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1.0 MHz		180 20	235 25	pF pF
Switchi d(on)	ng Characteristics Turn-On Delay Time	V		25	60	ns
r	Turn-On Rise Time	$V_{DD} = 250 \text{ V}, \text{ I}_{D} = 13 \text{ A},$		100	210	ns
d(off)	Turn-Off Delay Time	R <sub>G</sub> = 25 Ω		130	270	ns
f	Turn-Off Fall Time	(Note 4, 5)		100	210	ns
ָ ג <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 13 A,		43	56	nC
ୁ C <sub>gs</sub>	Gate-Source Charge	$V_{GS} = 10 \text{ V}$		7.5		nC
קל ל <sup>מק</sup>	Gate-Drain Charge	(Note 4, 5)		18.5		nC
Drain-S	ource Diode Characteristics a	nd Maximum Ratings			1	1
s	Maximum Continuous Drain-Source Did	Maximum Continuous Drain-Source Diode Forward Current			13	Α
SM	Maximum Pulsed Drain-Source Diode F	Forward Current			52	Α
/ <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>S</sub> = 13 A			1.4	V
rr	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 13 A,$		410		ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F / dt = 100 \text{ A}/\mu \text{s} \qquad (\text{Note 4})$		4.5		μC
otes: Repetitive R L =6.0 mH, I I <sub>SD</sub> ≤ 13A, di Pulse Test :	ating : Pulse width limited by maximum junction tempe $_{AS} = 13A$ , $V_{DD} = 50V$ , $R_G = 25 \Omega$ , Starting $T_J = 25^{\circ}C$ $_{Jdt} \le 200A/\mu_S$ , $V_{DD} \le BV_{DSS}$ , Starting $T_J = 25^{\circ}C$ Pulse width $\le 300\mu_S$ , Duty cycle $\le 2\%$ ndependent of operating temperature	rature				



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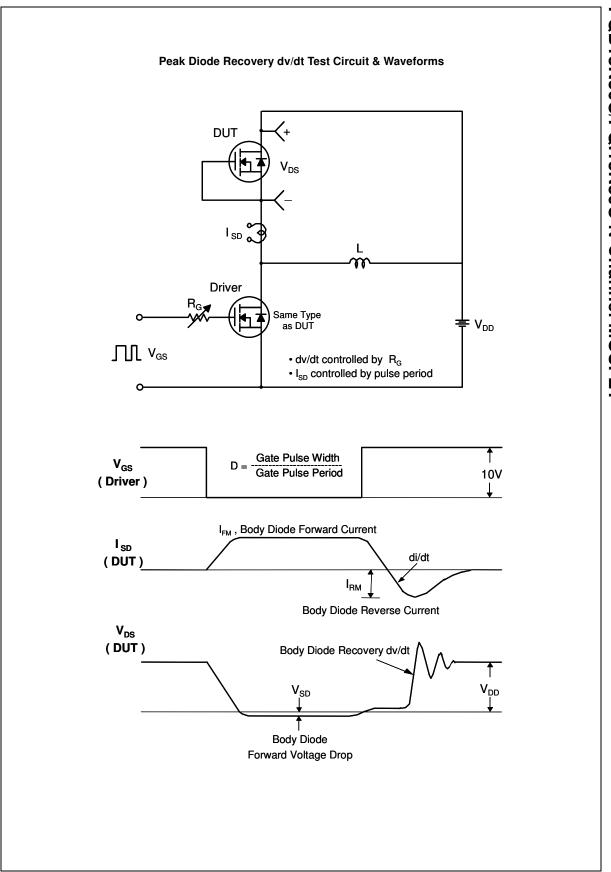
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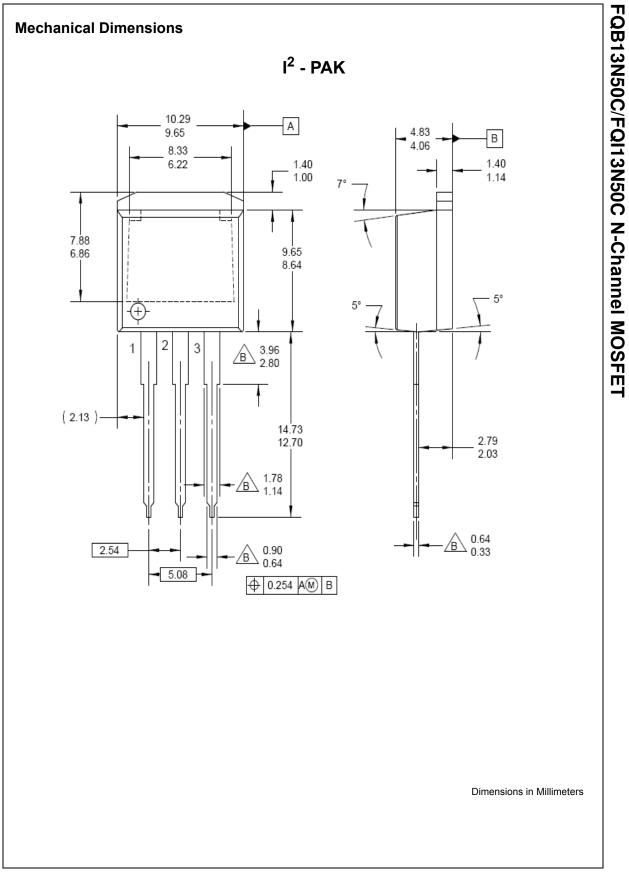


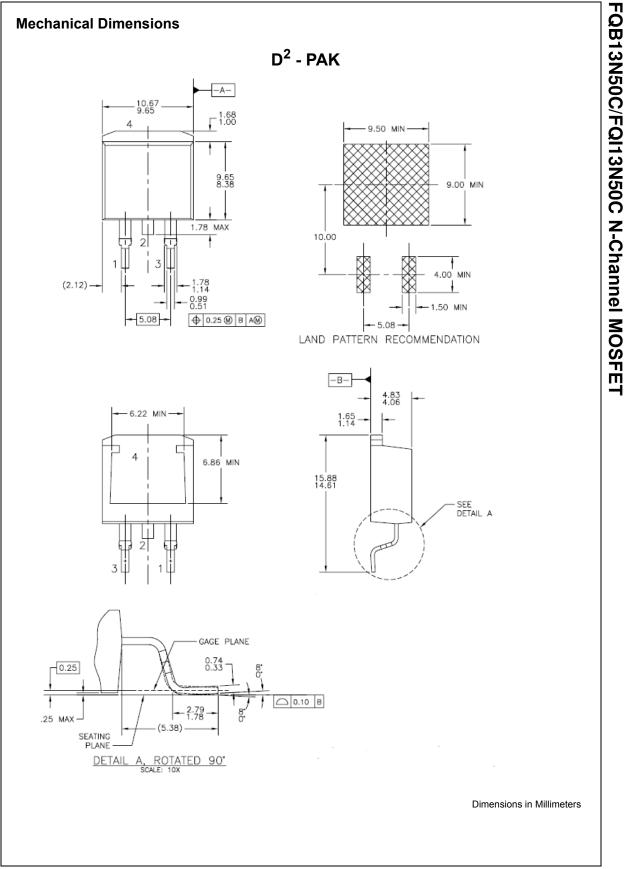


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